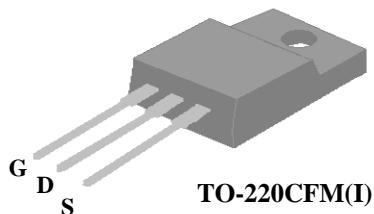




- ▼ Lower Gate Charge
- ▼ Simple Drive Requirement
- ▼ Fast Switching Characteristic

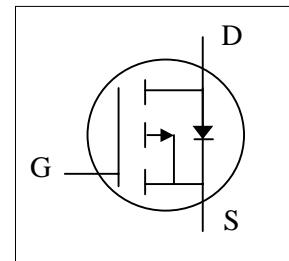


BV_{DSS}	-60V
$R_{DS(ON)}$	70mΩ
I_D	-16A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220CFM isolation package is universally preferred for all commercial-industrial through hole applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	-16	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	-10	A
I_{DM}	Pulsed Drain Current ¹	-60	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	31.25	W
	Linear Derating Factor	0.25	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Units
R_{thj-c}	Thermal Resistance Junction-case	Max. 4.0	°C/W
R_{thj-a}	Thermal Resistance Junction-ambient	Max. 65	°C/W



Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=-250\mu\text{A}$	-60	-	-	V	
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=-10\text{V}$, $I_{\text{D}}=-10\text{A}$	-	-	70	$\text{m}\Omega$	
		$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-8\text{A}$	-	-	90	$\text{m}\Omega$	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$	-1	-	-3	V	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_{\text{D}}=-10\text{A}$	-	14	-	S	
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=-60\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	-10	μA	
	Drain-Source Leakage Current ($T_j=150^\circ\text{C}$)	$V_{\text{DS}}=-48\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	-25	μA	
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}= \pm 20\text{V}$	-	-	± 100	nA	
Q_g	Total Gate Charge ²	$I_{\text{D}}=-10\text{A}$	-	21	34	nC	
Q_{gs}	Gate-Source Charge		-	5	-	nC	
Q_{gd}	Gate-Drain ("Miller") Charge		-	11	-	nC	
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ²	$V_{\text{DS}}=-30\text{V}$	-	10	-	ns	
t_r	Rise Time		$I_{\text{D}}=-10\text{A}$	-	18	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time			-	24	-	ns
t_f	Fall Time		$R_G=3.3\Omega$, $V_{\text{GS}}=-10\text{V}$	-	42	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	1760	2800	pF	
C_{oss}	Output Capacitance		-	160	-	pF	
C_{rss}	Reverse Transfer Capacitance		-	130	-	pF	
R_g	Gate Resistance	$f=1.0\text{MHz}$	-	5	8	Ω	

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_{\text{S}}=-10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	-	-1.3	V
t_{rr}	Reverse Recovery Time ²	$I_{\text{S}}=-10\text{A}$, $V_{\text{GS}}=0\text{V}$, $dI/dt=-100\text{A}/\mu\text{s}$	-	46	-	ns
	Reverse Recovery Charge		-	100	-	nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

THIS PRODUCT IS ELECTROSTATIC SENSITIVE, PLEASE HANDLE WITH CAUTION.

THIS PRODUCT HAS BEEN QUALIFIED FOR USE IN CONSUMER APPLICATIONS. APPLICATIONS OR USE IN LIFE SUPPORT OR OTHER SIMILAR MISSION-CRITICAL DEVICES OR SYSTEMS ARE NOT AUTHORIZED.

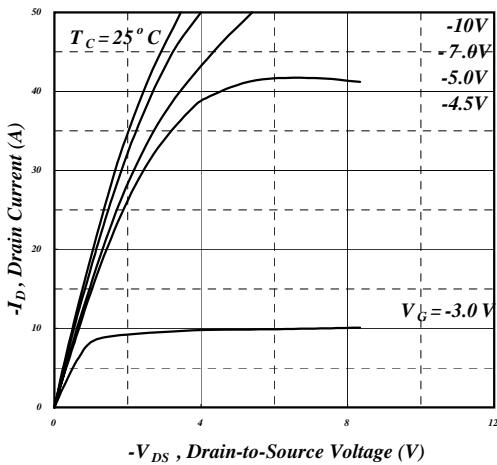


Fig 1. Typical Output Characteristics

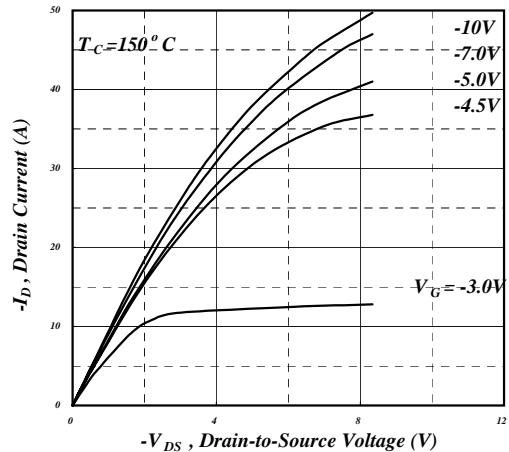


Fig 2. Typical Output Characteristics

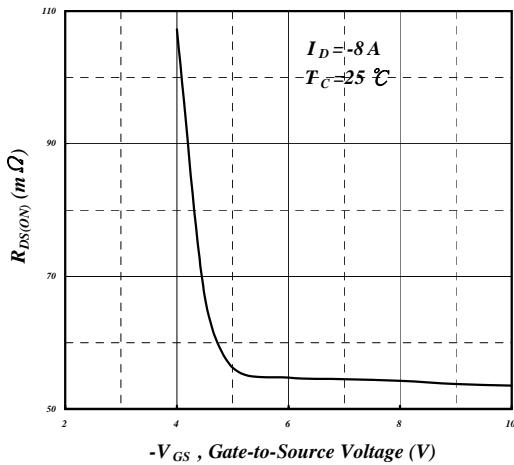


Fig 3. On-Resistance v.s. Gate Voltage

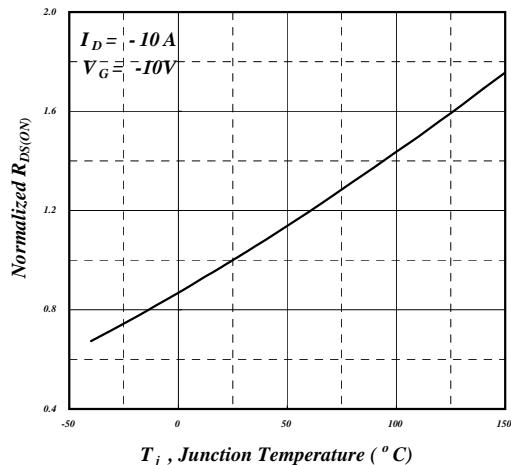


Fig 4. Normalized On-Resistance v.s. Junction Temperature

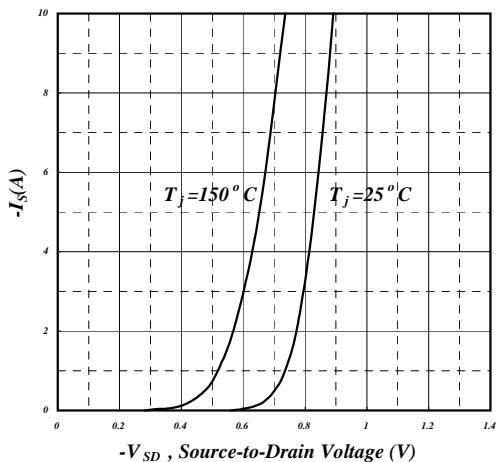


Fig 5. Forward Characteristic of Reverse Diode

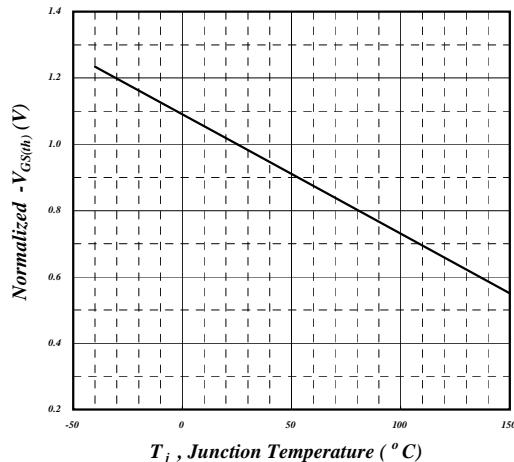


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

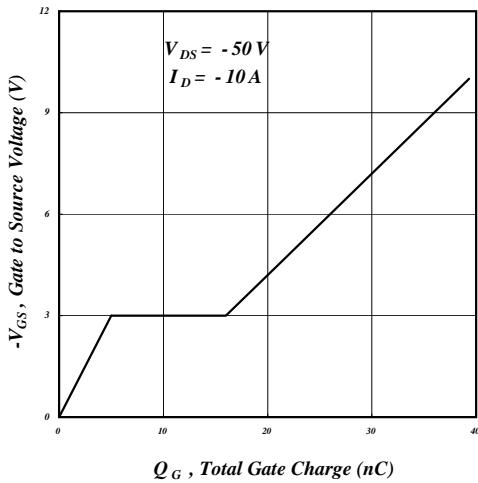


Fig 7. Gate Charge Characteristics

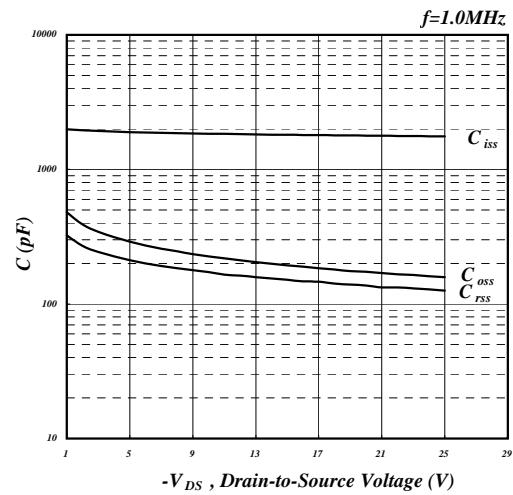


Fig 8. Typical Capacitance Characteristics

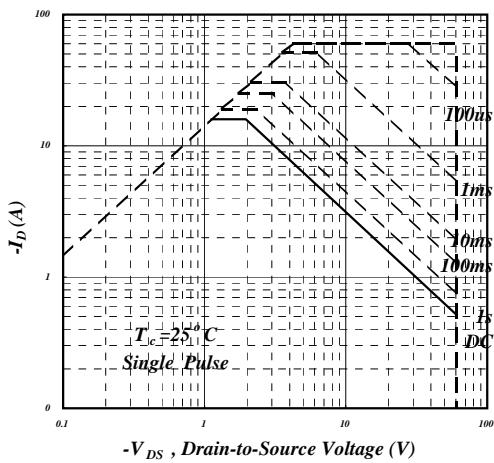


Fig 9. Maximum Safe Operating Area

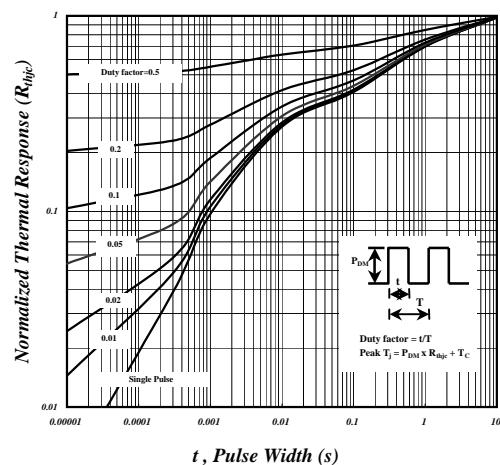


Fig 10. Effective Transient Thermal Impedance

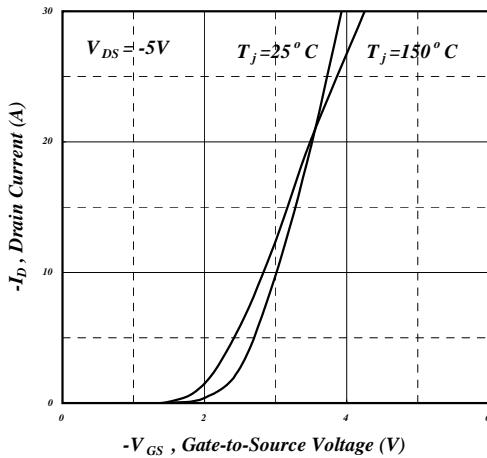


Fig 11. Transfer Characteristics

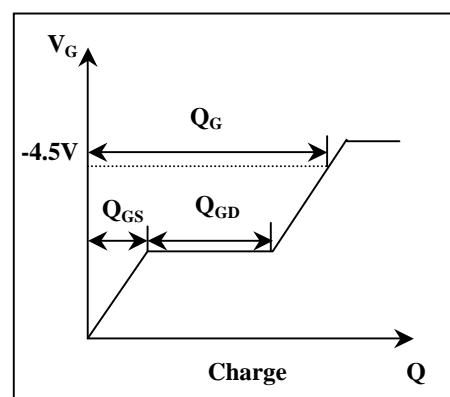


Fig 12. Gate Charge Waveform